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March 2012

FAN5640 — Dual High-Side Constant Current Source for High-Voltage Keypad LED Illumination

Features

- 20V Maximum Driver Input Level
- Dual Output
- 25mA Drive Capability per Channel
- Two Strings of 2-4 LEDs Each
- External Resistor Sets Maximum Current
- Fast Turn-On/Off Capability
- Low Bias Current
- SC70-6 Package
- Thermal Shutdown Protection

Applications

- Keypad Illumination
- Main Display and Sub-Display Illumination
- Cell Phones, Smart Phones
- Pocket PCs
- PDA, DSC, PMP, and MP3 Players

Description

The FAN5640 is designed to illuminate one or two strings of keypad LEDs with constant high-side current sources.

The device can drive up to four white LEDs in series at a maximum current of 25mA per channel. If the second channel is not needed, the channels can be tied together to boost output current up to 50mA.

An external resistor programs the maximum output current. Dimming can be accomplished by pulse width modulation of the enable pin or the input supply rail.

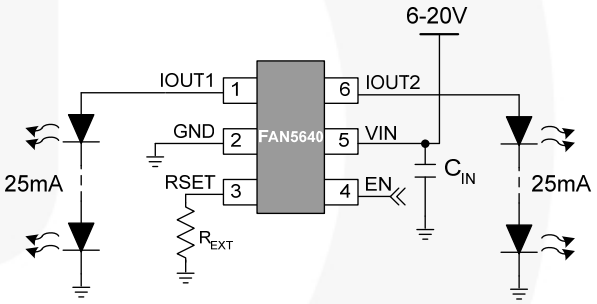


Figure 1. Typical Application

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FAN5640S7X	-40°C to 85°C	SC70-6 2x2.2mm	Tape and Reel

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Block Diagram

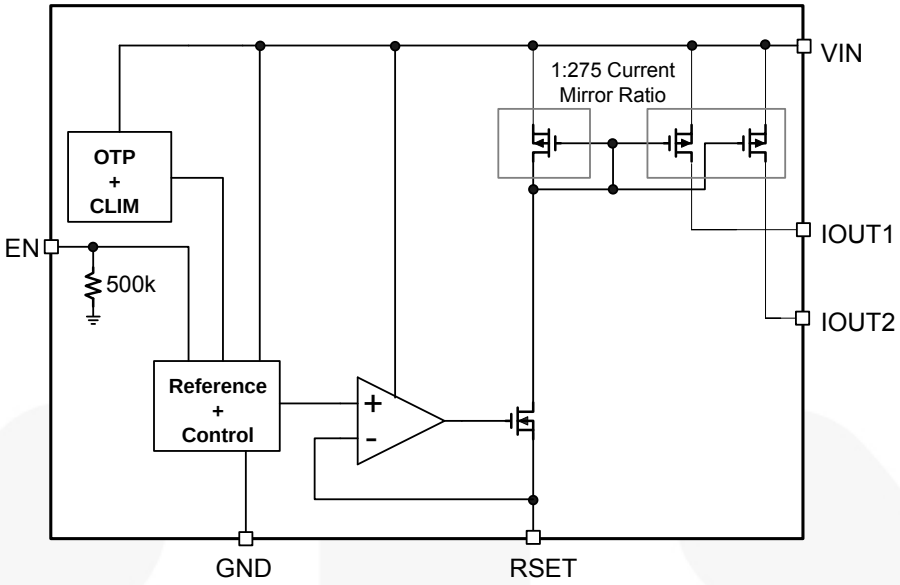


Figure 2. Block Diagram

Pin Configuration

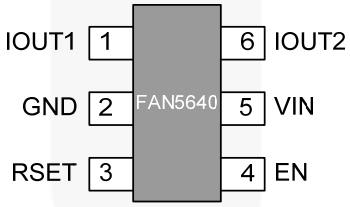


Figure 3. Pin Assignments

Pin Definitions

Pin #	Name	Description
1	IOUT1	**Output Current 1**. The programmed current I_{OUT} is sourced from this pin. If only one channel is used, IOUT1 and IOUT2 can be tied together to boost the output current. It can also be left floating or tied to pin 5.
2	GND	**Ground**
3	RSET	**RSET**. Connect a programming resistor R_{EXT} to this pin. This pin's output voltage is 0.475V when EN is HIGH. The current through the external resistor establishes the current I_{OUT}, where I_{OUT} = 275 • [0.475V / R_{EXT}].
4	EN	**Enable**. When HIGH, the IC applies the programmed current I_{OUT} to both IOUT1 and IOUT2. When LOW, IC enters Shutdown Mode. If pulsed, this pin modulates the output current. The minimum pulse width is determined by the speed of the turn-on circuitry. This pin contains an internal pull-down resistor of 500KΩ.
5	VIN	**Input Supply**. Apply 6 to 20V at this pin *(see Dropout Limitations under the Application Information section)*.
6	IOUT2	**Output Current 2**. The programmed current I_{OUT} is sourced from this pin. If only one channel is used, IOUT1 and IOUT2 can be tied together to boost the output current. It can also be left floating or tied to pin 5.

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V_{EN}	Enable Voltage		-0.3	6.0	V
	V_{IN}, V_{IOUT1}, V_{IOUT2}		-0.3	22.0	V
I_{RSET}	Current Sourced by RSET			120	μA
T_J	Junction Temperature		-40	150	°C
T_{STG}	Storage Temperature		-65	150	°C
T_L	Lead Soldering Temperature, 10 Seconds			260	°C
ESD	Electrostatic Discharge Protection Level	Human Body Model	2		kV
		Charged Device Model	2		

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IN}	Supply Voltage	6		20	V
V_{EN}	Enable Voltage			5.5	V
I_{OUT1}, I_{OUT2}	Output Current Range Through Each String	2.5		25.0	mA
T_A	Operating Ambient Temperature Range[1]	-40		+85	°C
T_J	Operating Junction Temperature Range[1]	-40		+125	°C

Thermal Properties

Symbol	Parameter	Min.	Typ.	Max.	Unit
Θ_{JA}	Junction to Ambient Thermal Resistance[1]		300		°C/W

Note:

1. Junction-to-Ambient thermal resistance is a function of application and board layout. This data is measured with four-layer, 1s2p boards in accordance with JESD51- JEDEC standard. Special attention must be paid not to exceed the maximum junction temperature.

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Electrical Characteristics

V_{IN} = 6V to 20V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = 25°C, V_{IN} = 14V, I_{LED} = 15mA.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Power Supplies						
V_{IN}	Input Voltage Range		6		20	V
I_Q	Quiescent Current	Measured at GND pin, V_{IN} = 20V		48	65	µA
		Measured at GND pin, V_{IN} = 6V		44	55	
I_{SD}	Shutdown Supply Current	V_{IN} = 20V, EN = GND		8	13	µA
		V_{IN} = 6V, EN = GND		5	8	
V_{EN}	Enable High-Level Input Voltage		1.2			V
	Enable Low-Level Input Voltage				0.4	
I_{EN}	Enable Input Current	EN = 5V		9	15	µA
		EN=GND		0.1	1.0	
Regulation						
I_{LIM1}	Channel 1 Current Limit(2)		30			mA
I_{LIM2}	Channel 2 Current Limit(2)		30			mA
ΔI_{OUT}	Output Current Accuracy	2.5mA < I_{OUT} ≤ 5mA(3)	-15		+15	%
		5mA < I_{OUT} ≤ 25mA(3)	-10		+10	
I_{MATCH}	Channel-to-Channel Current Matching(4)		-3		+3	%
V_{DO}	Output Dropout Voltage	V_{IN} – V_{OUT} at 90% I_{OUT} Programmed I_{OUT} = 25mA		1.80	2.50	V
		V_{IN} – V_{OUT} at 90% I_{OUT} Programmed I_{OUT} = 2.5mA		0.43	0.60	
V_{REF}	Reference Voltage			475		mV
I_{MIRROR}	Current Mirror Ratio	I_{OUT} / I_{RSET}		275		
$\Delta I_{OUT}/\Delta V_{IN}$	Power Supply Current Dependency	V_{OUT} = V_{IN} – 2V(5)		0.5	2.0	%/V
T_{ON}	Turn-On Time	V_{IN}=14V , I_{OUT}=12.5mA(6)		5	8	µs
TSD	Thermal Shutdown Protection	Rising Temperature		150		°C
		Hysteresis		20		

Notes:

2. If only one channel is needed, IOUT1 can be tied to IOUT2 to boost maximum current to 50mA.
3. R_{EXT} resistor tolerance adds to the specification limit of the pin RSET to determine overall current accuracy.
4. Matching defined as $[(I_{OUT1}-I_{OUT2})/(I_{OUT1}+I_{OUT2})]\times100$.
5. V_{OUT} is the total voltage drop across the LED string.
6. Measured from EN crossing 1.8V to output current reaching 90% of target I_{OUT}.

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Typical Characteristics

Unless otherwise noted, C_{IN} = 4.7µF, V_{EN}=1.8V, T_A = 25°C, white LED with V_F=3.3V at I_{OUT}=10mA.

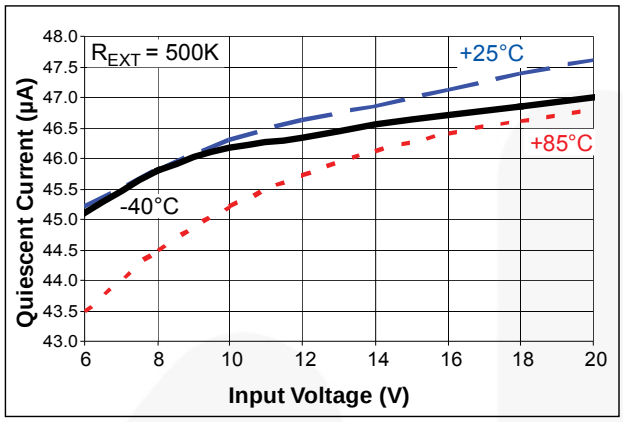


Figure 4. Quiescent Current vs. Input Voltage

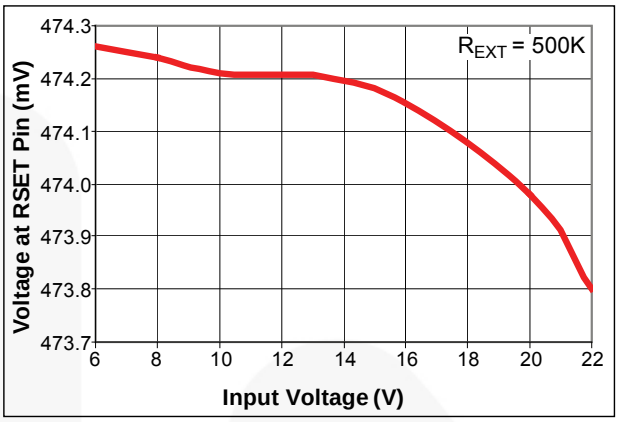


Figure 5. RSET Voltage vs. Input Voltage

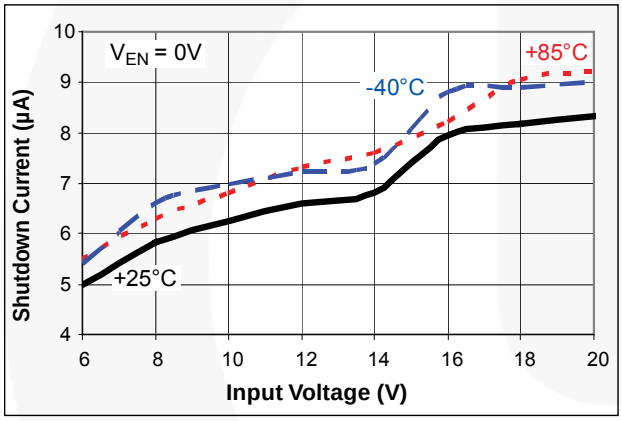


Figure 6. Shutdown Current vs. Input Voltage

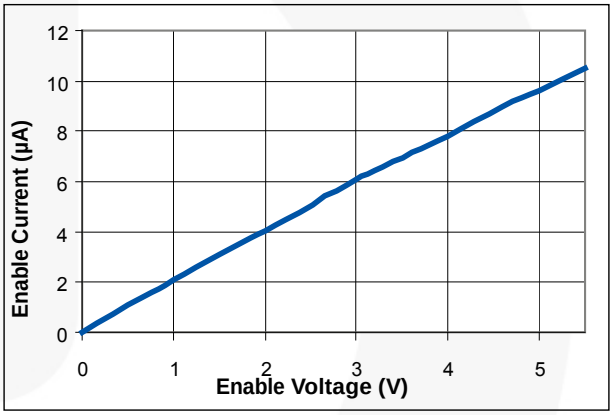


Figure 7. Enable Input Current vs. Enable Voltage

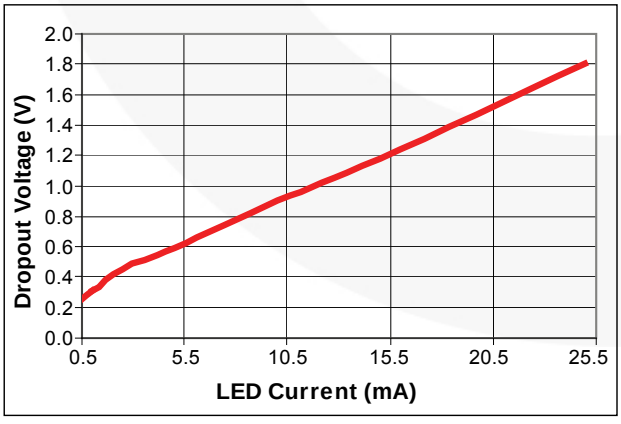


Figure 8. Dropout Voltage vs. LED Current

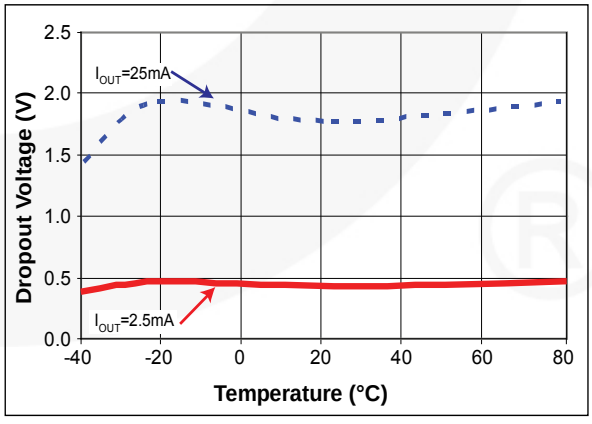


Figure 9. Dropout Voltage vs. Temperature

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Typical Characteristics (Continued)

Unless otherwise noted, C_{IN} = 4.7µF, V_{EN}=1.8V, T_A = 25°C, white LED with V_F=3.3V at I_{OUT}=10mA.

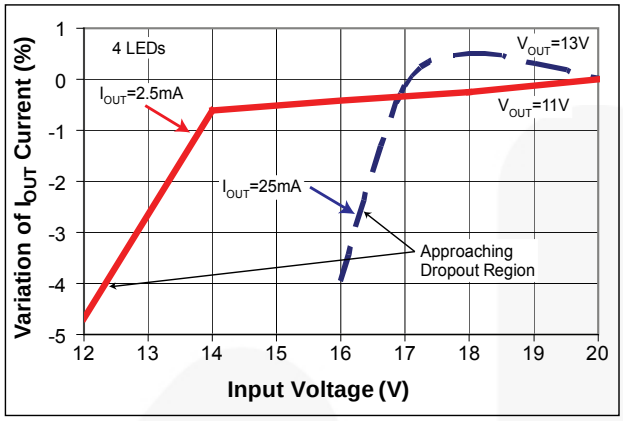


Figure 10. Line Regulation

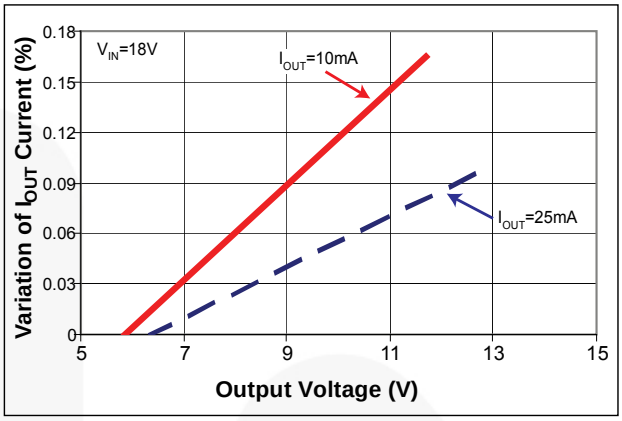


Figure 11. Variation of I_{OUT} Current vs. Output Voltage

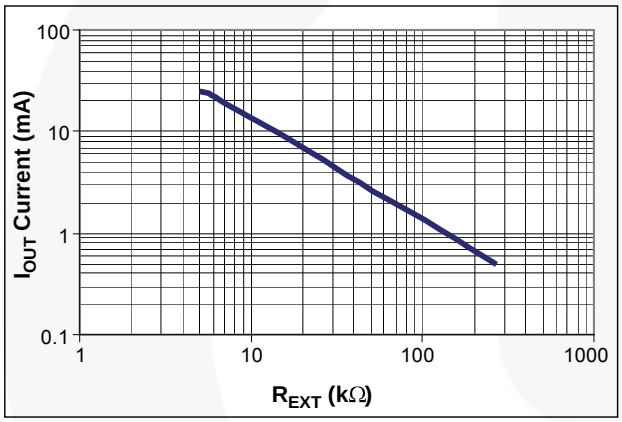


Figure 12. I_{OUT} Current vs. R_{EXT} Voltage

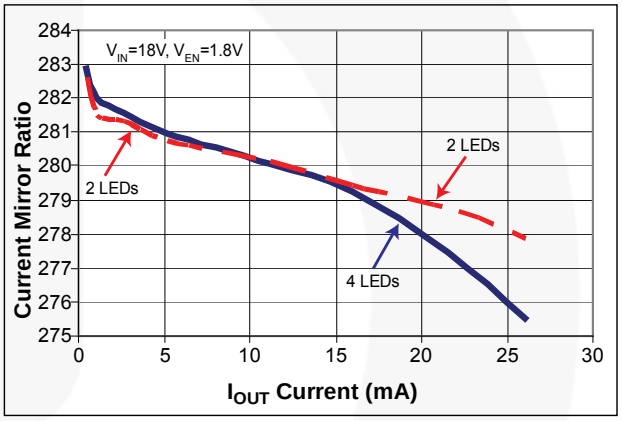


Figure 13. Current Mirror Ratio vs. LED Current

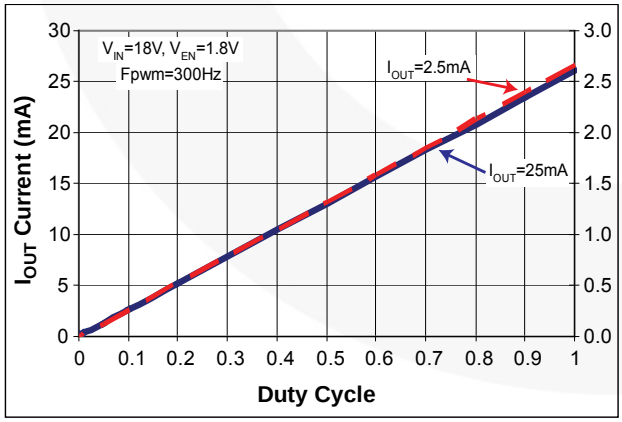


Figure 14. PWM Dimming on EN Pin

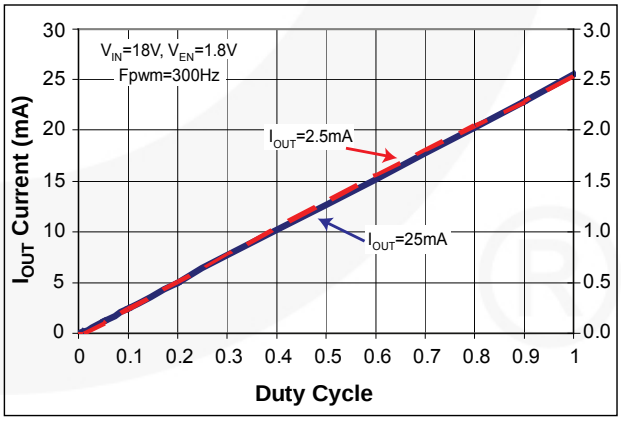


Figure 15. PWM Dimming on VIN Pin

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Typical Characteristics (Continued)

Unless otherwise noted, C_{IN} = 4.7µF, V_{EN}=1.8V, T_A = 25°C, white LED with V_F=3.3V at I_{OUT}=10mA.

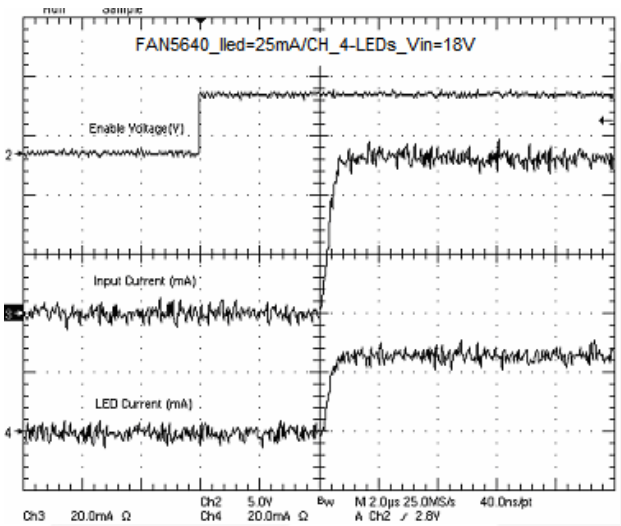


Figure 16. Turn-On at Full Load

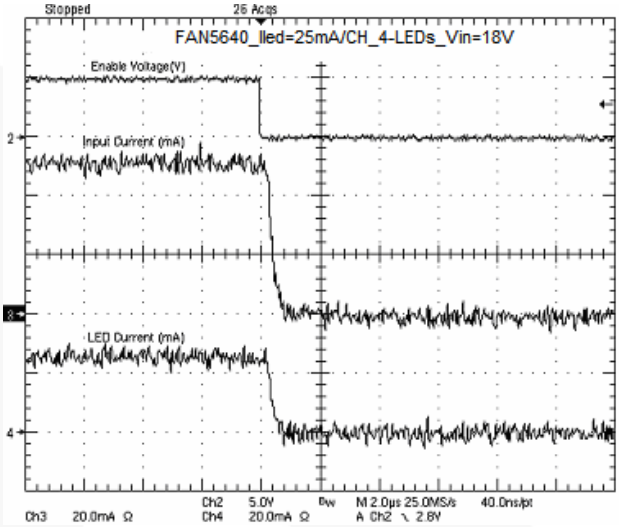


Figure 17. Turn-Off at Full Load

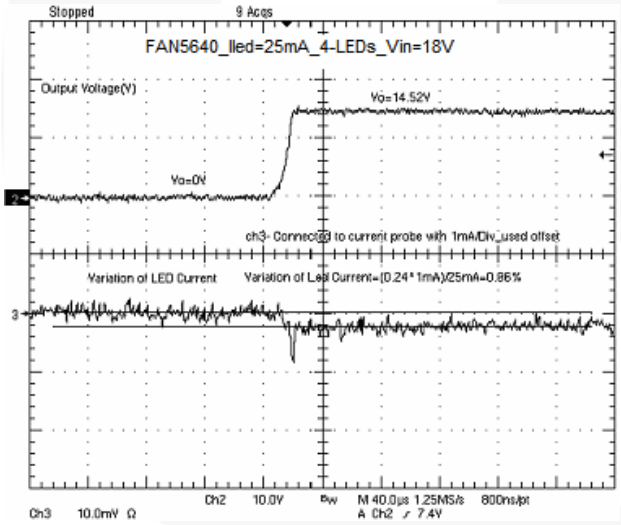


Figure 18. Load Transient Response (V_{OUT} Low to High)

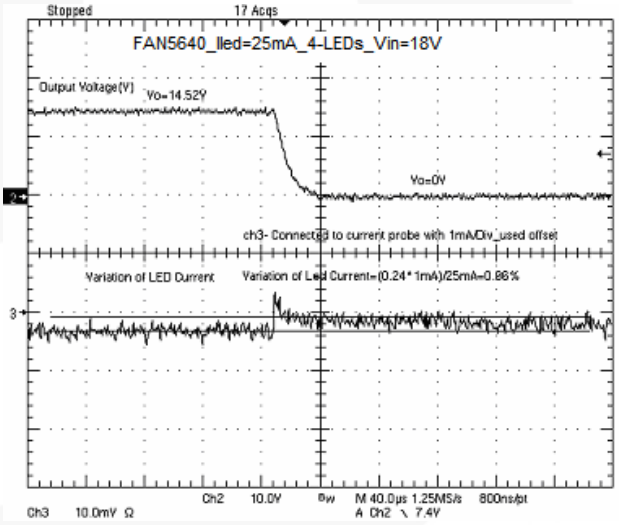


Figure 19. Load Transient Response (V_{OUT} High to Low)

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Application Information

Setting the Output Current Level

An internally generated reference current is mirrored on the MOSFETs connected to the outputs IOUT1 and IOUT2 (pins 1 and 6, respectively). The current mirror ratio is 275 (typical). The voltage on pin 3 (RSET) is 0.475V in steady state; therefore, the programmed current through each of the outputs is:

$$I_{OUT} = 275 \times \frac{0.475}{R_{EXT}} \qquad \text{EQ. 1}$$

where R_{EXT} is the external resistor connected from pin 3 to ground. Increasing this external programming resistor reduces the output current. For the maximum rated 25mA rating of each output, the minimum value of the external resistor is:

$$R_{EXT} = 275 \times \frac{0.475}{I_{OUT}} = 275 \times \frac{0.475}{0.025} = 5.225k\Omega \qquad \text{EQ. 2}$$

The LED output current accuracy is ±10% for 25mA current (*see the Electrical Characteristics table*). In the worst-case scenario, the calculated value of I_{OUT} can lead to an error of ±10% in the LED current. Since the tolerance of R_{EXT} also affects the LED current accuracy, a precision resistor should be chosen to have the least effect on the overall accuracy of the LED current (*see Figure 12*).

Floating vs. Tied Outputs

Unused outputs can be left floating. The current through is zero, regardless of the current programmed at pin 3. However, ESD protection is enhanced if the unused output pin is tied to VIN (pin 5).

If the two output pins are tied together, they can deliver a combined 50mA for the same programming resistor of 5.225kΩ.

External Capacitors

Because the FAN5640 is stable without capacitors on the outputs, no capacitors are recommended. Typical input decoupling usually present on incoming supply rails should suffice in most applications. If necessary, a small input capacitance may be placed between the input pin and ground without adverse effects.

Dropout Limitations

As for any LDO regulator, there are limitations on how close the input and output rails can be to maintain regulation. The minimum difference is referred to as the dropout. The relevant information is provided in the Typical Performance curve Dropout Voltage vs. LED Current (*see Figure 8*). The equation for the data is:

$$V_{DO} = 0.35V + I_{OUT} \times 64\Omega \qquad \text{EQ. 3}$$

This is equivalent to an R_{DS} of 64Ω with an additional offset of 350mV. This equation is helpful in determining the minimum dissipation in the device and the lowest input voltage for a given application.

Multiple LED Displays

For portable applications, the FAN5640 can be powered from the output of any typical boost regulator. Multiple LED displays can be created with the FAN5640 powered from the output of the FAN5333, as shown in Figure 20. Note that the output voltage of the FAN5333 depends upon the number of LEDs in its output string. Being conscious of the minimum dropout requirements of the FAN5640; if three series LEDs are required to be present at its output, then the FAN5333 should have four series LEDs in its output string.

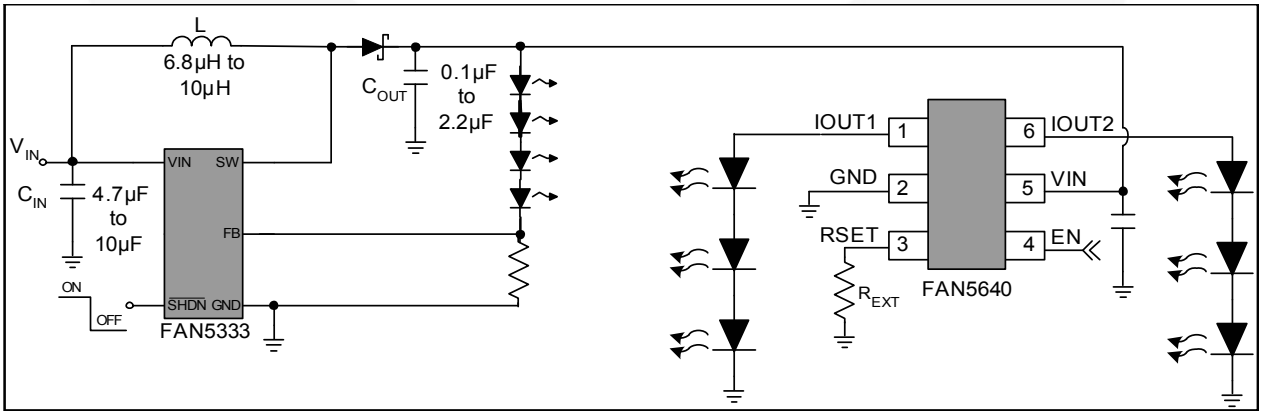


Figure 20. LED Display Example

PWM Dimming

PWM dimming can be implemented by toggling the enable (EN) pin (pin 4). The recommended PWM frequency range is 100Hz to 3kHz. For example, if the rise time is 2.2µs, the actual duty cycle applied internally to the output MOSFETs is slightly less than the duty cycle of the signal applied on the enable pin. This leads to a slight non-linearity in the measured LED current. That error is:

$$\frac{\Delta I_{OUT}}{I_{OUT_SET}} = -\frac{(2.2\mu \times f_{PWM})}{D_{PWM}} \times 100\% \quad \text{EQ. 4}$$

For example, at a PWM frequency of 3kHz, with an applied duty cycle of 10%, the typical error is:

$$\frac{\Delta I_{OUT}}{I_{OUT_SET}} = -\frac{(2.2\mu \times 3k)}{0.1} \times 100 = -6.6\% \quad \text{EQ. 5}$$

So, if R_{SET} is 5.225kΩ, the theoretically expected LED current, with a PWM duty cycle of 10%, is 2.5mA. However, the actual (measured) LED current is less by 6.6%. It is (1-0.066) multiplied by 2.5mA, which is 2.335mA. In this way, the actual LED current for any PWM duty cycle and frequency can be estimated.

Input Rail Dimming

The LEDs can also be dimmed by modulating the input supply rail. *See Figure 15, PWM Dimming By VIN Pin, under Typical Characteristics.* A maximum frequency of 1KHz is recommended.

Power Dissipation

At an ambient temperature (T_A), the power dissipation (P_D) and the junction temperature (T_J) are related to each other as described in the following equation:

$$T_J = T_A + P_D \times \Theta_{JA} \quad \text{EQ. 6}$$

where:

$$P_D = (V_{IN} - V_O) \times I_{OUT_Total} + V_{IN} \times I_Q + \frac{V_{RSET}}{R_{EXT}} \times (V_{IN} - V_{RSET})$$

and

$I_{OUT_Total} = I_{OUT1} + I_{OUT2}$.

The quiescent current (I_Q) can be found in the Electrical Characteristics section. The junction-to-ambient thermal resistance (Θ_{JA}) puts a limit on V_{O_MAX}, I_{OUT_MAX}, and the maximum dropout $(V_{IN}\text{-}V_O)_{MAX}$. This affects the number of LEDs used, the current used to drive them, and so on. Ensure that thermal shutdown does not occur. The formula that correlates all these variables is:

$$(V_{IN} - V_O)_{MAX} = \frac{T_{J_MAX} - T_{A_MAX}}{\Theta_{JA} \times I_{OUT_Total}} \quad \text{EQ. 7}$$

This should be solved for T_{J_MAX} and the result verified as less than the over-temperature shutdown threshold of 150ºC (typical). An additional 25ºC margin is recommended to account for tolerances on the shutdown threshold; T_{J_MAX} should not exceed 125ºC. The Θ_{JA} is dependent on the surrounding PCB layout and can be around 300ºC/W for an SC-70 package. This can be improved by providing a heat sink of surrounding copper ground on the PCB. The addition of backside copper with vias, stiffeners, and other enhancements can reduce this value. The heat contributed by the dissipation of other devices located nearby must be included in design considerations. Once the limiting parameters in these two relationships have been determined, the design can be modified to ensure that the device remains within specified operating conditions. If overload conditions are not considered, it is possible for the device to enter a thermal cycling loop, in which the circuit enters a shutdown condition, cools, re-enables, and again overheats and shuts down repeatedly due to an unmanaged fault condition.

LED Selection

The FAN5640 is designed to drive 2-4 LEDs or a higher number of monochrome LEDs. The maximum number of LEDs per channel can be calculated as a function of V_{IN} and the sum of the forward voltage of each LED at the maximum specified current. The minimum number of LEDs driven by FAN5640 is the result of calculating the maximum power dissipated by the IC in the given operating conditions. The forward voltage of LEDs depends upon type of LEDs and the manufacturer. In terms of maximum number of LEDs and LED current, refer to the Dropout Voltage vs. LED Current graph in the Typical Characteristics (*see Figure 8*).

Manufacturer	Part	Website
HARVATEK	HT-T169TW	www.harvatek.com
NICHIA	NSSW1087	www.nichia.com

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Physical Dimensions

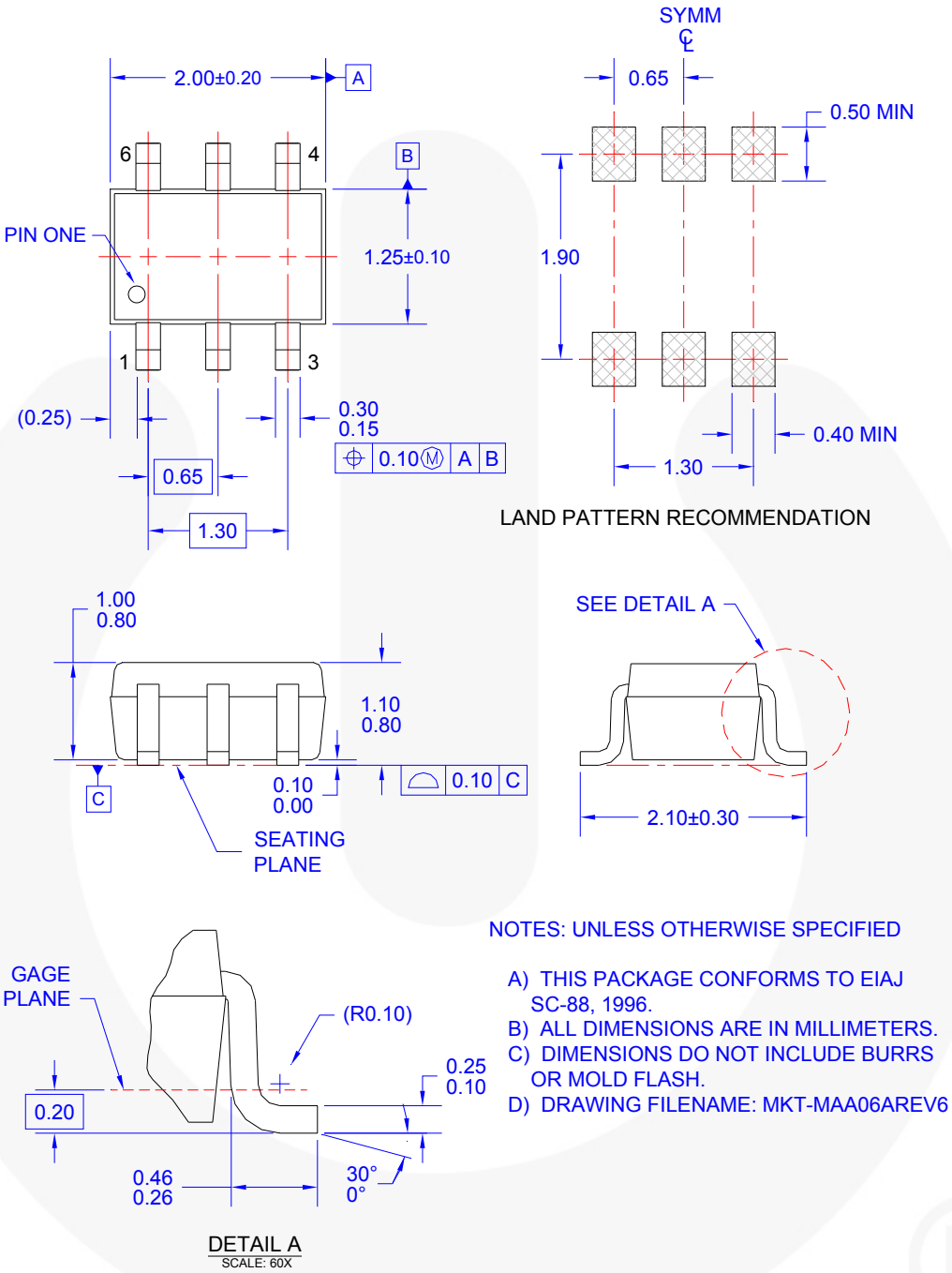


Figure 21. 6-Lead SC-70 Package Dimensions

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